















## CHEMICALS FOR ETCHING METHODS

Order No.	Product	Application / Property
 B09-0212	Ferric Chloride, normal 45 °Bé	Ferric chloride solution with a density of 45 °Bé for etching of the cylinders copper coating
B09-0213	SW One-bath Ferric Chloride. FH 48 °Bé	One-bath etching solution (density 48 °Bé) on ferric chloride basis with additives for constant etching of the cylinders copper coating
B09-0216	Ferric Chloride 45 °Bé with side wall protection	Ferric chloride solution with a density of 45 °Bé and side wall protection additive for equal etching
 B09-8002	Cupric Chloride Dihydrate	Product for etching of the copper cylinder according to the Think-process
 B03-0541	Laser Lacquer black	Lacquer for rotogravure cylinder production according laser burning technique
 B03-0590	Laser Lacquer H-B 212	For copper
 B01-0593	Laser Lacquer H-BYC 200	For steel
B03-0542	Thinner for Laser Lacquer	
 B01-0191	Thinner for Laser Lacquer H-B 212 and H-BYC 200	
 A03-0498	Laser-Activator	Cleaning and activation of the copper surface after direct lasering
 B09-0175	Acid-proof Copying Layer HR 100/NS	Set for copy-technical etching in copper by a negative film; hardening by UV light; the layers are acid-proof; removal of not hardened areas with developer
 B09-0169	Thinner HR	
 B09-0172	Developer HR	
 B07-0057	White Shrink Iron	Roller cover for etching machines
 C03-0030	Tampon made of Styrofoam	With round edges